

Structure	Silicon monolithic integrated circuit
Product	Power Management Switch
Type	BD6520F
Feature	Low on resistance (Typ. = 50mΩ) Output load current (I _{out} 0 ~ 2A) Control input : High Active

◇ Absolute Maximum Rating (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply Voltage	V _{DD}	-0.3 ~ 6.0	V
CTRL Input Voltage	V _{CTRL}	-0.3 ~ 6.0	V
Switch Output Voltage	V _{OUT}	-0.3 ~ V _{DD} + 0.3	V
Storage Temperature	T _{STG}	-55 ~ 150	°C
Power Dissipation *1	P _d	560	mW

*1 This value decreases 4.48mW/°C above 25°C.

- * Resistance radiation design is not doing.
- * Operation is not guaranteed.

◇ Operating Conditions

Parameter	Symbol	MIN	TYP	MAX	Unit
Supply Voltage	V _{DD}	3.0	5.0	5.5	V
Switch Current	I _{sw}	0	-	2	A

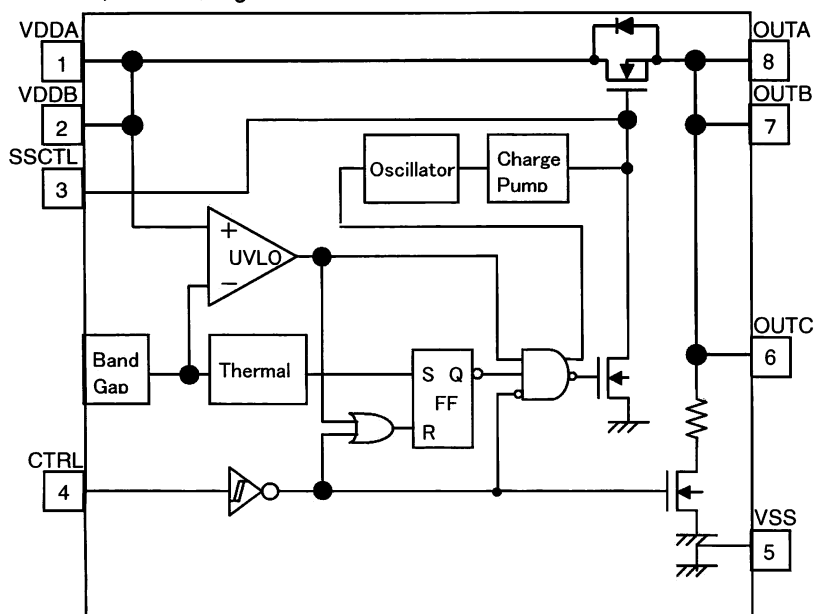
Application example

- ROHM cannot provide adequate confirmation of patents.
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◇ Electrical Characteristics (Unless otherwise specified Ta=25°C, V_{DD}=5V)

Parameter	Symbol	Limits			Unit	Condition
		Min.	Typ.	Max.		
On Resistance	R _{ON1}	-	50	70	mΩ	V _{DD} =5V, V _{CTRL} =5V
	R _{ON2}	-	60	85	mΩ	V _{DD} =3V, V _{CTRL} =3V
Operating Current	I _{DD}	-	110	220	μA	V _{CTRL} =5V, OUT=OPEN
	I _{DDST}	-	-	2	μA	V _{CTRL} =0V, OUT=OPEN
Control Input Voltage	V _{CTRL} L	-	-	0.7	V	V _{CTRL} L = Low Level
	V _{CTRL} H	2.5	-	-	V	V _{CTRL} H = High Level
Control Input Current	I _{CTRL}	-1	0	1	μA	V _{CTRL} = L , H
Turn on Delay	Trd	200	1000	2000	μs	RL=10Ω, SSCTL=OPEN CTRL = L→H → OUT=50%
Turn On Rise Time	Tr	500	2000	7500	μs	RL=10Ω, SSCTL=OPEN OUT=10% → 90%
Turn Off Delay	Tfd	-	3	20	μs	RL=10Ω, SSCTL=OPEN CTRL = H→L → OUT = 50%
Turn Off Fall Time	Tf	-	1	20	μs	RL=10Ω, SSCTL=OPEN OUT=90% → 10%
Discharge Resistance	R _{SWDC}	-	350	600	Ω	V _{DD} =5V, V _{CTRL} =0V, V _{OUT} =5V
UVLO Threshold Voltage	V _{UVLO} H	2.3	2.5	2.7	V	Increasing V _{DD}
	V _{UVLO} L	2.1	2.3	2.5	V	Decreasing V _{DD}
UVLO Hysteresis Voltage	V _{HYS}	100	200	300	mV	V _{HYS} = V _{UVLO} H - V _{UVLO} L
Thermal Shutdown Threshold	T _{TS}	-	135	-	°C	V _{CTRL} = 5V
SSCTL	V _{SSCTL}	-	13.5	-	V	V _{CTRL} = 5V

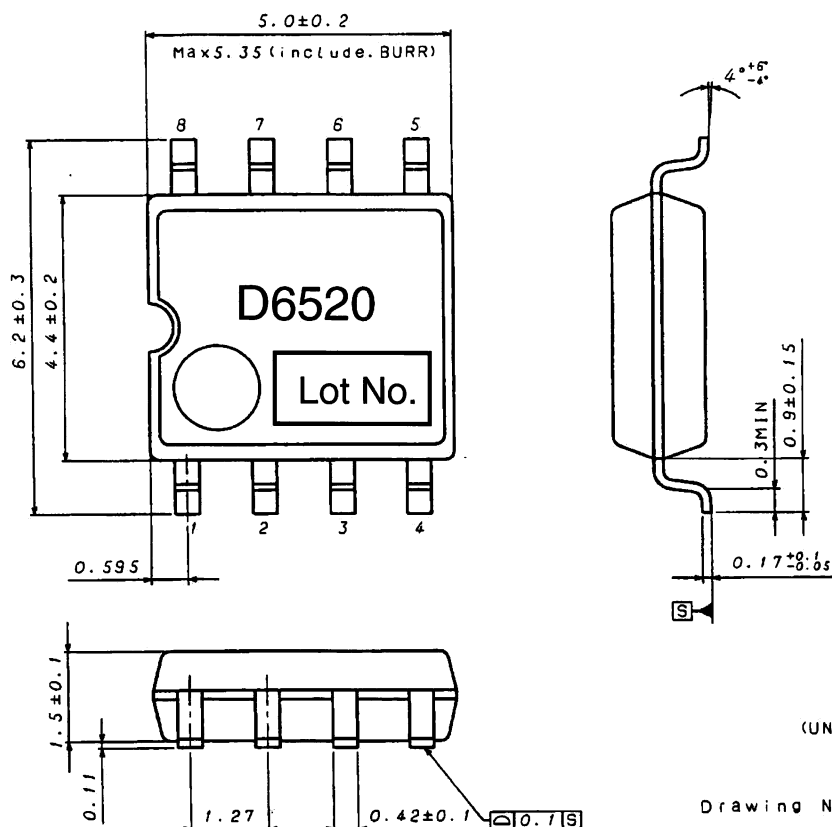
◇ Block Diagram



◇ Pin Description

Pin Number	Pin Name	Pin Function
1 2	VDDA VDDB	Supply Input
3	SSCTL	Soft Start setting
4	CTRL	Enable Input
5	GND	Ground
6 7 8	OUTC OUTB OUTA	Switch Output

◇ Package Outline



SOP 8 (Unit : mm)

(UNIT : mm)

Drawing No. EX112-5002

◇Cautions on use

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Power supply and GND line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines. Pay attention to the interference by common impedance of layout pattern when there are plural power supplies and GND lines. Especially, when there are GND pattern for small signal and GND pattern for large current included the external circuits, separate each GND pattern. Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use a capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(3) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(4) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

(5) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(6) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(7) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(8) Thermal shutdown circuit (TSD)

When junction temperatures become 135°C (typ) or higher, the thermal shutdown circuit operates and turns a switch OFF. The thermal shutdown circuit, which is aimed at isolating the LSI from thermal runaway as much as possible, is not aimed at the protection or guarantee of the LSI. Therefore, do not continuously use the LSI with this circuit operating or use the LSI assuming its operation.

(9) Thermal design

Perform thermal design in which there are adequate margins by taking into account the power dissipation (Pd) in actual states of use.

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U.S.A / San Diego	TEL : +1(858)625-3630	FAX : +1(858)625-3670
Atlanta	TEL : +1(770)754-5972	FAX : +1(770)754-0691
Dallas	TEL : +1(972)312-8818	FAX : +1(972)312-0330
Germany / Dusseldorf	TEL : +49(2154)9210	FAX : +49(2154)921400
United Kingdom / London	TEL : +44(1)908-282-666	FAX : +44(1)908-282-528
France / Paris	TEL : +33(0)1 56 97 30 60	FAX : +33(0) 1 56 97 30 80
China / Hong Kong	TEL : +852(2)740-6262	FAX : +852(2)375-8971
Shanghai	TEL : +86(21)6279-2727	FAX : +86(21)6247-2066
Dalian	TEL : +86(411)8230-8549	FAX : +86(411)8230-8537
Beijing	TEL : +86(10)8525-2483	FAX : +86(10)8525-2489
Taiwan / Taipei	TEL : +866(2)2500-6956	FAX : +866(2)2503-2869
Korea / Seoul	TEL : +82(2)8182-700	FAX : +82(2)8182-715
Singapore	TEL : +65-6332-2322	FAX : +65-6332-5662
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Philippines / Manila	TEL : +63(2)807-6872	FAX : +63(2)809-1422
Thailand / Bangkok	TEL : +66(2)254-4890	FAX : +66(2)256-6334

Japan /
(Internal Sales)

Tokyo	2-1-1, Yaesu, Chuo-ku, Tokyo 104-0082	
	TEL : +81(3)5203-0321	FAX : +81(3)5203-0300
Yokohama	2-4-8, Shin Yokohama, Kohoku-ku, Yokohama, Kanagawa 222-8575	
	TEL : +81(45)476-2131	FAX : +81(45)476-2128
Nagoya	Dainagayo Building 9F 3-28-12, Meieki, Nakamura-ku, Nagoya, Aichi 450-0002	
	TEL : +81(52)581-8521	FAX : +81(52)561-2173
Kyoto	579-32 Higashi Shiokouji-cho, Karasuma Nishi-iru, Shiokoujidori, Shimogyo-ku, Kyoto 600-8216	
	TEL : +81(75)311-2121	FAX : +81(75)314-6559
(Contact address for overseas customers in Japan)		
Yokohama	TEL : +81(45)476-9270	FAX : +81(045)476-9271